

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
Stylesheet Version v1.2

Assignment ID: PATI1219435

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
ROHM Co. Ltd.	08/08/2025
RECEIVING PARTY DATA	
Company Name:	REED SEMICONDUCTOR CORP.
Street Address:	875 Centerville Rd
Internal Address:	Unit 2 Fl 2
City:	Warwick
State/Country:	RHODE ISLAND
Postal Code:	02886-4366
PROPERTY NUMBERS Total: 1	
Property Type	Number
Patent Number:	7960955
CORRESPONDENCE DATA	
Fax Number:	6508434001
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Phone:	6508434000
Email:	PAPatentDocket@morganlewis.com
Correspondent Name:	Mr. Andrew Gray IV
Address Line 1:	1400 Page Mill Road
Address Line 4:	Palo Alto, CALIFORNIA 94304-1124
ATTORNEY DOCKET NUMBER:	135364-5001
NAME OF SUBMITTER:	Avery Welker
SIGNATURE:	/Avery Welker/
DATE SIGNED:	08/15/2025
Total Attachments: 2	
source=ROHM_REED_20250807#page1.tiff	
source=ROHM_REED_20250807#page2.tiff	

MPS
Exhibit 1011
MPS v. Reed
IPR2026-00165

TRANSFER ASSIGNMENT DOCUMENTS

THIS ASSIGNMENT is effective as of August 8, 2025 by and between ROHM Co. Ltd., a corporation existing under the laws of Japan, having its principal place of business at 21 Saiin Mizosaki-cho, Ukyo-ku, Kyoto 615-8585 Japan, ("Seller") and REED SEMICONDUCTOR CORP, a Delaware corporation, having its principal place of business at 875 Centerville Road, Floor2, Building2, Warwick, RI 02886 USA ("Purchaser").

"WHEREAS in this Assignment, "Patents" means:

- (a) a specific patent or patent application listed in Exhibit "A";

AND WHEREAS Seller owns all interest, right, title, property and benefit in and to each of the Patents and has agreed to assign all interest, right, title, property and benefit in and to each of the Patents to Purchaser;

NOW, THEREFORE, in consideration of good and valuable consideration, the receipt and sufficiency of which are hereby expressly acknowledged, Seller hereby sells, assigns, transfers, conveys and sets over to Purchaser (1) all of Seller's interest, right, title, property and benefit in and to each of the Patents, (2) the sole right to collect any damages for past, current and future infringement of each of the Patents to the extent not covered by license agreements or forbearances existing as of the date hereof that have been expressly disclosed to Purchaser prior to the date hereof and (3) the right to sue for past, current and future infringement of each of the Patents.

IN WITNESS WHEREOF, Seller has caused this Assignment to be executed effective as of the date first written above by its duly authorized officer.

REED SEMICONDUCTOR CORP

Signed: Wenlai Wu
Name: Wenlai Wu
Title: General Manager
Reed Semiconductor Corp.
(a company incorporated in Delaware)

.....
Authorized Signatory

Country of USA
City of Warwick, RI 02886

ROHM Co. Ltd.,

Signed: Koji Taniuchi
Name: Koji Taniuchi
Title: General Manager
Intellectual Property Division

Country of Japan
City of Kyoto

Exhibit "A"
Patents

Family
US 7,960,955
US 7,960,955

Patent
US 7,960,955
JP4721891

W.W.

K.T.